# High Speed Transistor Optocouplers

Single Channel: HCPL0453, HCPL0500, HCPL0501 Dual Channel: HCPL0531, HCPL0534

# HCPL0453, HCPL0500, HCPL0501, HCPL0531, HCPL0534

### Description

The HCPL05XX, and HCPL04XX optocouplers consist of an AlGaAs LED optically coupled to a high speed photo-detector transistor housed in a compact 8-pin small outline package.

A separate connection for the bias of the photodiode improves the speed by several orders of magnitude over conventional phototransistor optocouplers by reducing the base–collector capacitance of the input transistor. The HCPL04XX devices do not have the base bonded out to a lead for additional noise margin. The HCPL053X devices have two channels per package for optimum mounting density.

### Features

- High Speed 1 MBit/s
- 15 kV/µs Minimum Commone Mode Transient Immunity at V<sub>CM</sub> = 1500 V (HCPL0453/0534)
- Open Collector Output
- Guaranteed Performance Over Temperature: 0°C to 70°C
- U.L. Recognized (File # E90700)
- VDE0884 Recognized (File # 136616)
  - Approval Pending for HCPL0531/0453
    Ordering Option V, e.g., HCPL0500V
- BSI Recognized (File # 8661, 8662)
   HCPL0500/0501 only

#### Applications

- Line Receivers
- Pulse Transformer Replacement
- Output Interface to CMOS-LSTTL-TTL
- Wide Bandwidth Analog Coupling

#### TRUTH TABLE (Positive Logic)

LED	v <sub>o</sub>
ON	LOW
OFF	HIGH

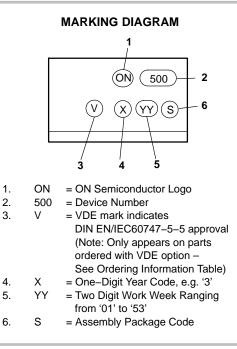


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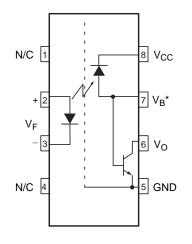
SOIC8 CASE 751DZ

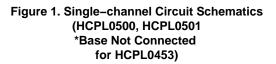


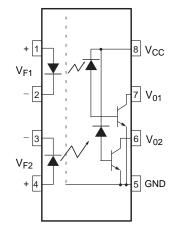
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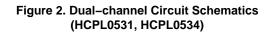
See detailed ordering and shipping information on page 7 of this data sheet.

## SCHEMATICS









Symbol	Parameter	Value	Units
T <sub>STG</sub>	Storage Temperature	-40 to +125	۵°
T <sub>OPR</sub>	Operating Temperature	-40 to +85	°C
	Reflow Temperature Profile (Refer to page 7)		
MITTER			
I <sub>F</sub> (avg)	DC/Average Forward Input Current	25	mA
I <sub>F</sub> (pk)	Peak Forward Input Current (50% duty cycle, 1 ms P.W.)	50	mA
I <sub>F</sub> (trans)	Peak Transient Input Current (t ≤ 1 µs P.W., 300 pps)	1.0	А
V <sub>R</sub>	V <sub>R</sub> Reverse Input Voltage		V
PD	Input Power Dissipation	45	mW
ETECTOR			
l <sub>O</sub> (avg)	Average Output Current (Pin 6)	8	mA
I <sub>O</sub> (pk) Peak Output Current		16	mA
V <sub>EBR</sub>	Emitter-Base Reverse Voltage (HCPL0500/0501 only)	5	V
V <sub>CC</sub>	V <sub>CC</sub> Supply Voltage		V
V <sub>O</sub>	V <sub>O</sub> Output Voltage		V
Ι <sub>Β</sub>	I <sub>B</sub> Base Current (HCPL0500/0501 only)		mA
PD	Output Power Dissipation	100	mW

#### **ABSOLUTE MAXIMUM RATINGS** (T<sub>A</sub> = 25°C unless otherwise specified)

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

### **ELECTRICAL CHARACTERISTICS** ( $T_A = 0^{\circ}C$ to 70°C unless otherwise specified)

#### Symbol Parameter **Test Conditions** Device Min. Typ.\* Max. Unit EMITTER $V_{F}$ Input Forward Voltage $I_F = 16 \text{ mA}, T_A = 25^{\circ}\text{C}$ All 1.45 1.7 V $I_F = 16 \text{ mA}$ 1.8 5.0 Input Reverse Breakdown V $\mathsf{BV}_{\mathsf{R}}$ All I<sub>R</sub> = 10 μA Voltage -1.6 Temperature Coefficient of $\Delta V_{F} / \Delta T_{A}$ $I_{F} = 16 \text{ mA}$ All mV/°C Forward Voltage DETECTOR $I_F = 0 \text{ mA}, V_O = V_{CC} = 5.5 \text{ V},$ $T_A = 25^{\circ}\text{C}$ I<sub>OH</sub> Logic High Output Current All 0.001 0.5 μΑ All 0.005 1 $I_F = 0 \text{ mA}, V_O = V_{CC} = 15 \text{ V},$ $T_A = 25^{\circ}C$ $I_F = 0 \text{ mA}, V_O = V_{CC} = 15 \text{ V}$ All 50 Logic Low Supply Current 120 200 μΑ I<sub>CCL</sub> $I_F = 16 \text{ mA}, V_O = \text{Open}, V_{CC} = 15 \text{ V}$ HCPL0453/ 0500/1 HCPL0531/4 400 Logic High Supply Current 0.01 1 μΑ All ICCH $I_F = 0 \text{ mA}, V_O = \text{Open}, V_{CC} = 15 \text{ V},$ $T_A = 25^{\circ}C$ 2 $I_F = 0 \text{ mA}, V_O = \text{Open}, V_{CC} = 15 \text{ V}$ HCPL0453/ 0500/1 HCPL0531/4 4

#### INDIVIDUAL COMPONENT CHARACTERISTICS

#### TRANSFER CHARACTERISTICS

Symbol	Parameter	Test Conditions	Device	Min.	Тур.*	Max.	Unit
COUPLED							
CTR	Current Transfer Ratio		HCPL0500	7	27	50	%
	(Note 1)		HCPL0453	19	27	50	
			HCPL0501/0531				
		$I_F = 16 \text{ mA}, V_O = 0.5 \text{ V},$	HCPL0500	5	30		
		$V_{CC} = 4.5 V$	HCPL0453	15	30		
			HCPL0501/0534				
V <sub>OL</sub> Logic	Logic Low Output Voltage	$I_F = 16 \text{ mA}, I_O = 1.1 \text{ mA}, V_{CC} = 4.5 \text{ V}, T_A = 25^{\circ}\text{C}$	HCPL0500		0.18	0.4	V
		$I_F = 16 \text{ mA}, I_O = 3 \text{ mA}, V_{CC} = 4.5 \text{ V}, T_A = 25^{\circ}\text{C}$	HCPL0453		0.25	0.4	_
			HCPL0501/0531/4				
		$I_F = 16 \text{ mA}, I_O = 0.8 \text{ mA}, V_{CC} = 4.5 \text{ V}$	HCPL0500		0.13	0.5	
		$I_{\rm F} = 16 \text{ mA}, I_{\rm O} = 2.4 \text{ mA},$	HCPL0453		0.23	0.5	
	V <sub>CC</sub> = 4.5 V		HCPL0501/0531/4				

\*All typicals at  $T_A = 25^{\circ}C$ 

#### **ELECTRICAL CHARACTERISTICS** (CONTINUED) ( $T_A = 0^{\circ}C$ to 70°C unless otherwise specified)

#### Symbol Parameter **Test Conditions** Device Min. Typ.\* Max. Unit $T_A = 25^{\circ}C, R_I = 4.1 \text{ k}\Omega, I_F = 16 \text{ mA}$ HCPL0500 0.45 1.5 TPHL μS Propagation Delay Time to Logic LOW (Note 2) (Fig. 9) $R_L = 1.9 \text{ k}\Omega$ , $I_F = 16 \text{ mA}$ , $T_A = 25^{\circ}\text{C}$ HCPL0453 0.45 0.8 (Note 3) (Fig. 9) HCPL0501/0531/4 $R_{I} = 4.1 \text{ k}\Omega, I_{F} = 16 \text{ mA}$ HCPL0500 2.0 (Note 2) (Fig. 9) $R_{L} = 1.9 \text{ k}\Omega, I_{F} = 16 \text{ mA}$ HCPL0453 1.0 (Note 3) (Fig. 9) HCPL0501/0531/4 $T_A = 25^{\circ}C, R_I = 4.1 \text{ k}\Omega, I_F = 16 \text{ mA}$ 0.5 1.5 TPIH HCPL0500 μS Propagation Delay (Note 2) (Fig. 9) Time to Logic HIGH $R_L = 1.9 \text{ k}\Omega, I_F = 16 \text{ mA}, T_A = 25^{\circ}\text{C}$ HCPL0453 0.3 0.8 (Note 3) (Fig. 9) HCPL0501/0531/4 $R_L = 4.1 \text{ k}\Omega, I_F = 16 \text{ mA}$ HCPL0500 2.0 (Note 2) (Fig. 9) $R_{L} = 1.9 \text{ k}\Omega, I_{F} = 16 \text{ mA}$ HCPL0453 1.0 (Note 3) (Fig. 9) HCPL0501/0531/4 |CM<sub>H</sub>| HCPL0500 1.000 10.000 V/µs $I_{\text{F}} = 0 \text{ mA}, \text{ } V_{\text{CM}} = 10 \text{ } V_{\text{P-P}} \text{ } \text{ } \text{R}_{\text{L}} = 4.1 \text{ } \text{k}\Omega \text{,}$ Common Mode $T_A = 25^{\circ}C$ (Note 4) (Fig. 10) Transient Immunity at Logic HIGH HCPL0501/31 1.000 10,000 $I_F = 0 \text{ mA}, V_{CM} = 10 V_{P-P}, R_L = 1.9 \text{ k}\Omega$ $T_A = 25^{\circ}C$ (Note 4) (Fig. 10) 40,000 HCPL0534 15.000 $I_F = 0 \text{ mA}, V_{CM} = 1500 V_{P-P}, R_L = 1.9 \text{ k}\Omega, T_A = 25^{\circ}\text{C}$ (Note 4) (Fig. 10) HCPL0453 15.000 40.000 |CM<sub>L</sub>| HCPL0500 1.000 10.000 V/µs $I_F = 16 \text{ mA}, V_{CM} = 10 \text{ V}_{P-P}, R_L = 4.1 \text{ k}\Omega$ Common Mode Transient Immunity $T_A = 25^{\circ}C$ (Note 4) (Fig. 10) at Logic LOW HCPL0501/31 1.000 10,000 $I_F = 16 \text{ mA}, V_{CM} = 10 V_{P-P}, R_L = 1.9 \text{ k}\Omega$ (Note 4) (Fig. 10) 40.000 HCPL0534 15.000 $I_{F} = 16 \text{ mA}, \ T_{A} = 25^{\circ}\text{C}, \ V_{CM} = 1500 \ V_{P-P} \\ R_{L} = 1.9 \ k\Omega \ \ (Note \ 4) \ (Fig. \ 10)$ 40,000 HCPL0453 15,000

#### SWITCHING CHARACTERISTICS (TV<sub>CC</sub> = 5 V)

#### **ISOLATION CHARACTERISTICS**

Symbol	Characteristics	Test Conditions	Min.	Тур.*	Max.	Unit
V <sub>ISO</sub>	Input–Output Isolation Voltage	f = 60 Hz, t = 1.0 min., $I_{I-O} \le 2 \ \mu A$ (Notes 5, 6)	2500			Vac <sub>RMS</sub>
R <sub>ISO</sub>	Isolation Resistance	V <sub>I-O</sub> = 500V (Note 5)	10 <sup>11</sup>			
C <sub>ISO</sub>	Isolation Capacitance	V <sub>I-O</sub> = 0 V, f = 1.0MHz (Note 5)		0.2		pF

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

\*All typicals at  $T_A = 25^{\circ}C$ 

1. Current Transfer Ratio is designed as a ratio of output collector current, Io, to the forward LED input current, In times 100%.

2. The 4.1 k $\Omega$  load represents 1 LSTTL unit load of 0.36 mA and 6.1 k $\Omega$  pull-up resistor.

3. The 1.9 k $\Omega$  load represents 1 TTL unit load of 1.6 mA and 5.6 k $\Omega$  pull-up resistor.

4. Common mode transient immunity in logic high level is the maximum tolerable (positive)  $dV_{cm}/dt$  on the leading edge of the common mode pulse signal  $V_{CM}$ , to assure that the output will remain in a logic high state (i.e.,  $V_O > 2.0$  V). Common mode transient immunity in logic low level is the maximum tolerable (negative)  $dV_{cm}/dt$  on the trailing edge of the common mode pulse signal,  $V_{CM}$ , to assure that the output will remain in a logic low state (i.e.,  $V_O < 0.8$  V).

5. Device is considered a two terminal device: Pins 1, 2, 3 and 4 are shorted together and Pins 5, 6, 7 and 8 are shorted together.

6. 2500 VAC RMS for 1 minute duration is equivalent to 3000 VAC RMS for 1 second duration.

#### 1.2 1.0 NORMALIZED CTR 0.8 0.6 0.4 $V_0 = 0.4 V$ Normalized to: V<sub>CC</sub> = 5 V I<sub>F</sub> = 16 mA 0.2 $T_A = 25^{\circ}C$ 0.0 L 0.1 1 10 100 IF - FORWARD CURRENT (mA)

Figure 3. Normalized CTR vs. Forward Current

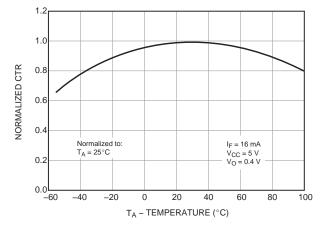


Figure 4. Normalized CTR vs. Temperature

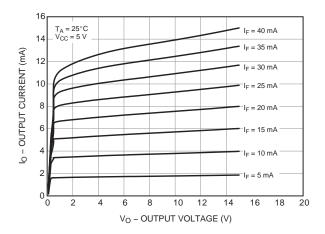


Figure 5. Output Current vs. Output Voltage

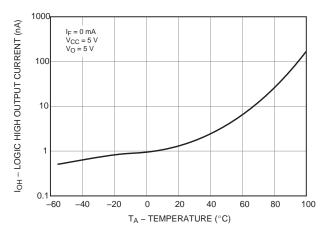
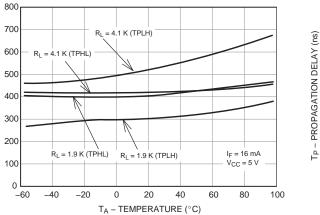


Figure 6. Logic High Output Current vs. Temperature



T<sub>p</sub> – PROPAGATION DELAY (ns)

Figure 7. Propagation Delay vs. Temperature

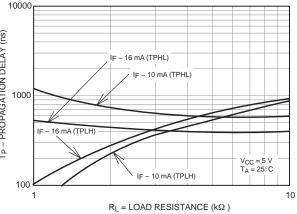
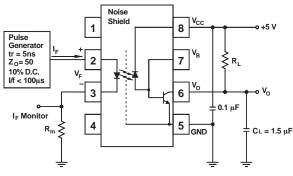
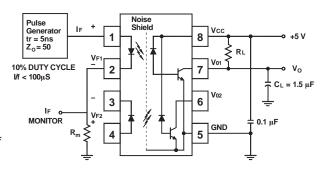


Figure 8. Propagation Delay vs. Load Resistance

## TYPICAL PERFORMANCE CURVES





Test Circuit for HCPL0453, HCPL0500 and HCPL0501

Test Circuit for HCPL0531 and HCPL0534

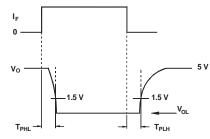
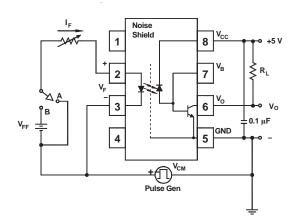
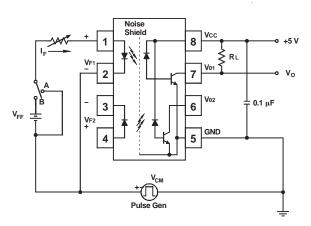


Figure 9. Switching Time Test Circuit



Test Circuit for HCPL0453, HCPL0500 and HCPL0501



Test Circuit for HCPL0531 and HCPL0534

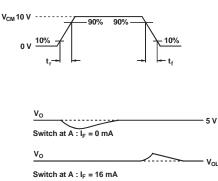


Figure 10. Common Mode Immunity Test Circuit

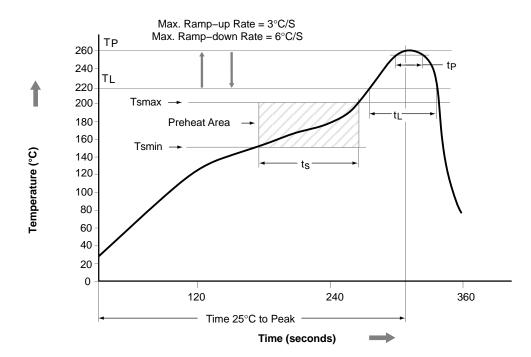
#### **ORDERING INFORMATION**

Part Nr./ Option (Note 7)	Order Entry Identifier	Package	Description	Packing Method <sup>†</sup>
HCPL0xxxV	V	SOIC8	VDE 0884 (approval pending for HCPL0531 & HCPL0534)	Tube (3000 Units)
HCPL0xxx <b>R2</b>	R2	SOIC8		Tape and Reel (2500 Units)
HCPL0xxx <b>R2V</b>	R2V	SOIC8	VDE 0884 (approval pending for HCPL0531 & HCPL0534)	Tape and Reel (2500 Units)

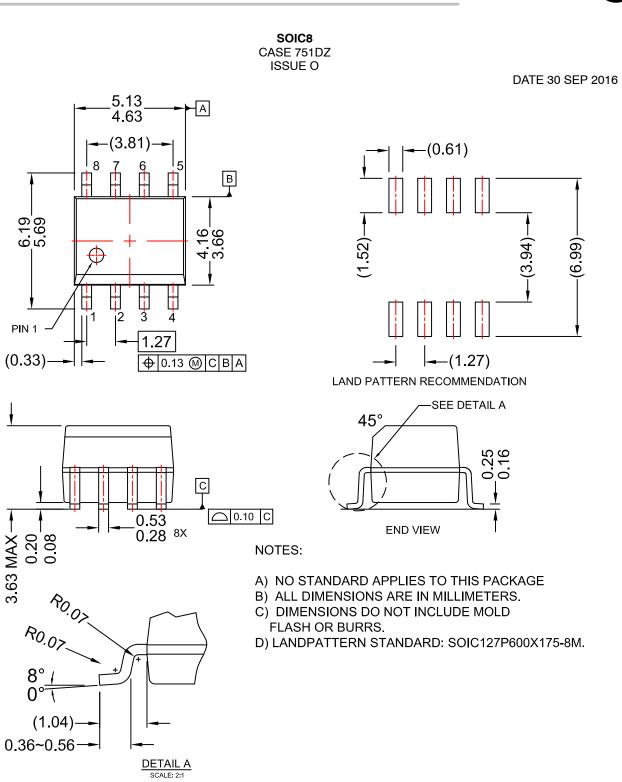
+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

 The product orderable part number system listed in this table also applies to the HCPL0453, HCPL0500, HCPL0501, HCPL0531 and HCPL0534 product.

### **REFLOW PROFILE**



Profile Freature	Pb-Free Assembly Profile
Temperature Min. (Tsmin)	150°C
Temperature Max. (Tsmax)	200°C
Time (t <sub>S</sub> ) from (Tsmin to Tsmax)	60–120 seconds
Ramp-up Rate (t <sub>L</sub> to t <sub>P</sub> )	3°C/second max.
Liquidous Temperature (T <sub>L</sub> )	217°C
Time ( $t_L$ ) Maintained Above ( $T_L$ )	60–150 seconds
Peak Body Package Temperature	260°C +0°C / –5°C
Time (t <sub>P</sub> ) within 5°C of 260°C	30 seconds
Ramp-down Rate (T <sub>P</sub> to T <sub>L</sub> )	6°C/second max.
Time 25°C to Peak Temperature	8 minutes max.



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